

## Temperature Rise Data

Product General Purpose Chip F	Resistors		Series	MCRS series	Туре	MCR18S EQP	Rated Power	0.4W
Test conditions①  Ambient temperature: Board specifications Cu foil thickness Number of layers of Cu foil Sample size Direct current application	: 25°C	80 70 60 50 40 30 20	Test conditions②  Ambient temperature: Board specifications Cu foil thickness Number of layers of Cu foil Sample size Direct current application  Test conditions①Hot spot Test conditions②Hot spot Test conditions②Hot spot Test conditions②Terminal Test conditions②Terminal	: 25°C : FR-4 t = 1 : 70µm	·	•	ot spot	0.4W
		10 0	25 50 定格電力比(%	75		100 (0.4W)		

## [Caution]

This data is the value of specific lot and specific resistance value only. It does not guarantee the variations due to different lot and product.

This data is not guaranteed. This data shall be utilized as reference data of the actual product characteristic.

When deciding the usage of the product, we cordially ask you not to only rely on this data but to have own evaluation and verification.

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